

# TK3P80E

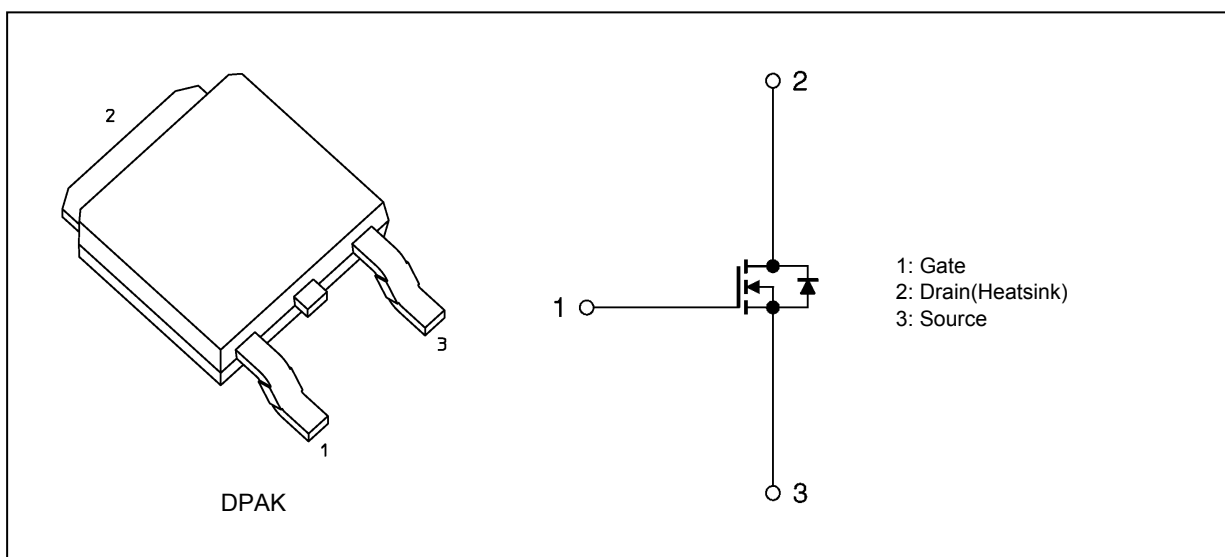
## 1. Applications

- Switching Voltage Regulators

## 2. Features

- (1) Low drain-source on-resistance:  $R_{DS(ON)} = 3.9 \Omega$  (typ.)
- (2) Low leakage current :  $I_{DSS} = 10 \mu A$  (max) ( $V_{DS} = 640 V$ )
- (3) Enhancement mode:  $V_{th} = 2.5$  to  $4.0 V$  ( $V_{DS} = 10 V$ ,  $I_D = 0.3 mA$ )

## 3. Packaging and Internal Circuit



## 4. Absolute Maximum Ratings (Note) ( $T_a = 25^\circ C$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	800	V
Gate-source voltage	$V_{GSS}$	$\pm 30$	
Drain current (DC) (Note 1)	$I_D$	3	A
Drain current (pulsed) (Note 1)	$I_{DP}$	9	
Power dissipation ( $T_c = 25^\circ C$ )	$P_D$	80	W
Single-pulse avalanche energy (Note 2)	$E_{AS}$	118	mJ
Avalanche current	$I_{AR}$	3	A
Reverse drain current (DC) (Note 1)	$I_{DR}$	3	
Reverse drain current (pulsed) (Note 1)	$I_{DRP}$	9	
Channel temperature	$T_{ch}$	150	$^\circ C$
Storage temperature	$T_{stg}$	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Start of commercial production

2014-02

## 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{th(ch-c)}$	1.56	°C/W

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2:  $V_{DD} = 90\text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial),  $L = 23.8\text{ mH}$ ,  $R_G = 25\ \Omega$ ,  $I_{AR} = 3\text{ A}$

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

## 6. Electrical Characteristics

### 6.1. Static Characteristics ( $T_a = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 30\text{ V}$ , $V_{DS} = 0\text{ V}$	—	—	$\pm 1$	$\mu\text{A}$
Drain cut-off current	$I_{DSS}$	$V_{DS} = 640\text{ V}$ , $V_{GS} = 0\text{ V}$	—	—	10	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10\text{ mA}$ , $V_{GS} = 0\text{ V}$	800	—	—	V
Gate threshold voltage	$V_{th}$	$V_{DS} = 10\text{ V}$ , $I_D = 0.3\text{ mA}$	2.5	—	4.0	
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{ V}$ , $I_D = 1.5\text{ A}$	—	3.9	4.9	$\Omega$

### 6.2. Dynamic Characteristics ( $T_a = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	$C_{iss}$	$V_{DS} = 25\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$	—	500	—	pF
Reverse transfer capacitance	$C_{rss}$		—	4	—	
Output capacitance	$C_{oss}$		—	40	—	
Gate resistance	$r_g$	$V_{DS} = \text{OPEN}$ , $f = 1\text{ MHz}$	—	5.0	—	$\Omega$
Switching time (rise time)	$t_r$	See Fig. 6.2.1.	—	25	—	ns
Switching time (turn-on time)	$t_{on}$		—	50	—	
Switching time (fall time)	$t_f$		—	22	—	
Switching time (turn-off time)	$t_{off}$		—	70	—	
MOSFET dv/dt ruggedness	dv/dt	$V_{DD} = 0\text{ to }400\text{ V}$ , $I_D = 3\text{ A}$	10	—	—	V/ns

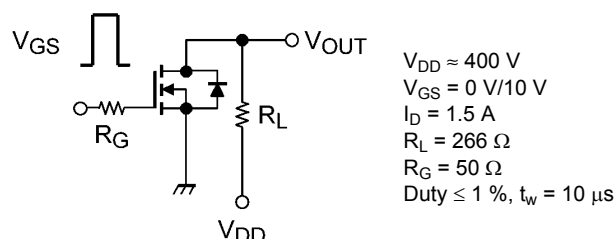


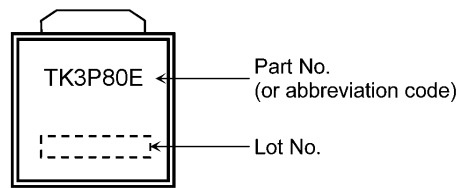
Fig. 6.2.1 Switching Time Test Circuit

### 6.3. Gate Charge Characteristics ( $T_a = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

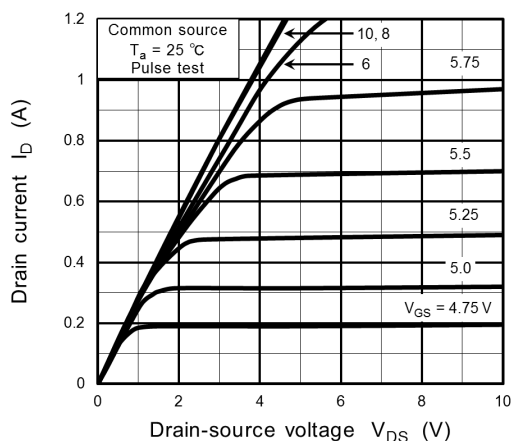
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} \approx 400\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 3\text{ A}$	—	12	—	nC
Gate-source charge 1	$Q_{gs1}$		—	4	—	
Gate-drain charge	$Q_{gd}$		—	5	—	

### 6.4. Source-Drain Characteristics ( $T_a = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

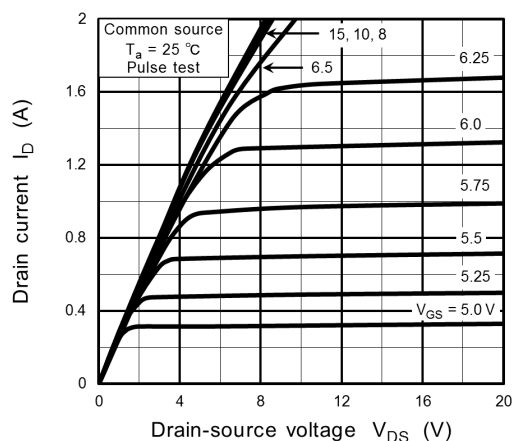
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Diode forward voltage	$V_{DSF}$	$I_{DR} = 3\text{ A}$ , $V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 3\text{ A}$ , $V_{GS} = 0\text{ V}$ $-dI_{DR}/dt = 100\text{ A}/\mu\text{s}$	—	800	—	ns
Reverse recovery charge	$Q_{rr}$		—	3.5	—	$\mu\text{C}$
Peak reverse recovery current	$I_{rr}$		—	11	—	A

**7. Marking****Fig. 7.1 Marking**

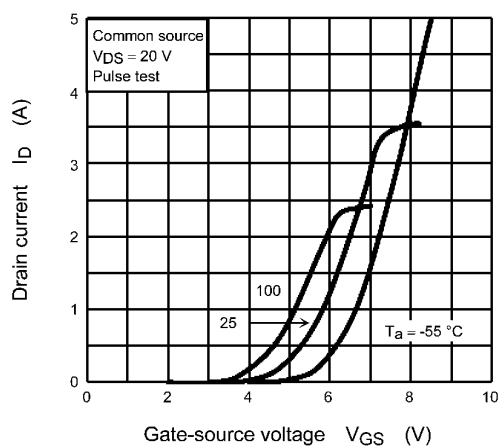
# 8. Characteristics Curves (Note)



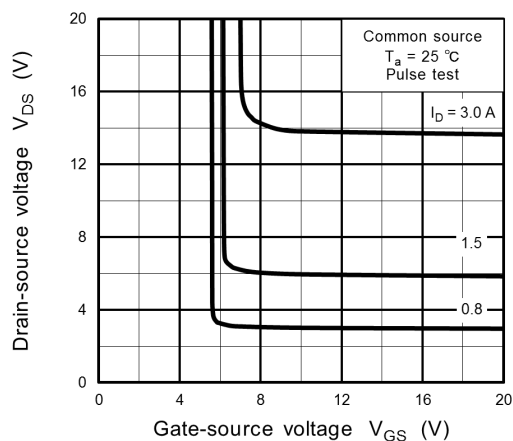
**Fig. 8.1**  $I_D - V_{DS}$



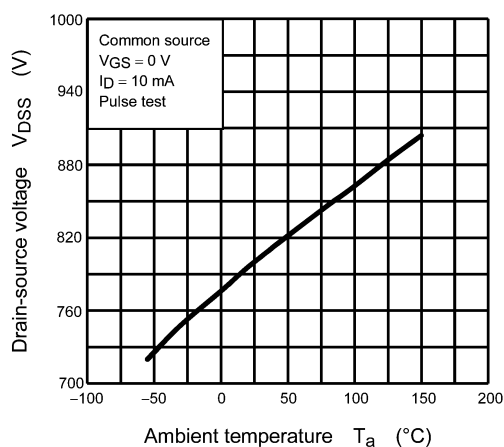
**Fig. 8.2**  $I_D - V_{DS}$



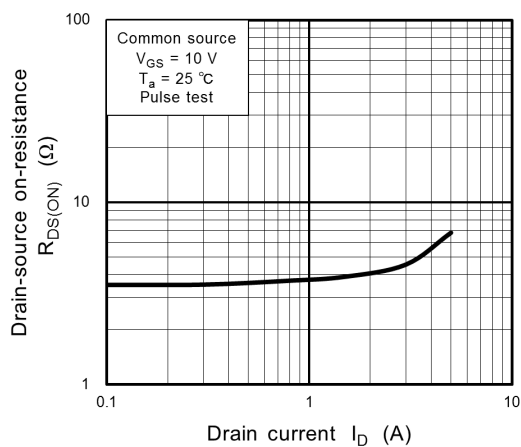
**Fig. 8.3**  $I_D - V_{GS}$



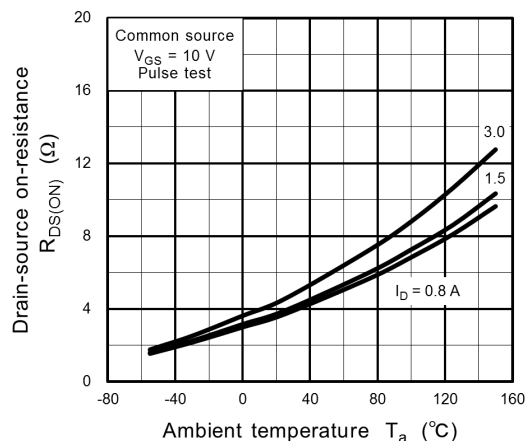
**Fig. 8.4**  $V_{DS} - V_{GS}$



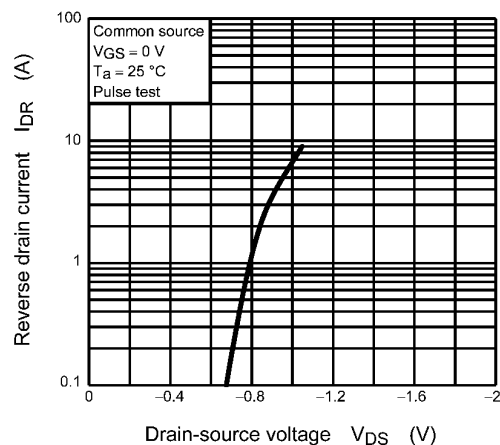
**Fig. 8.5**  $V_{DSS} - T_a$



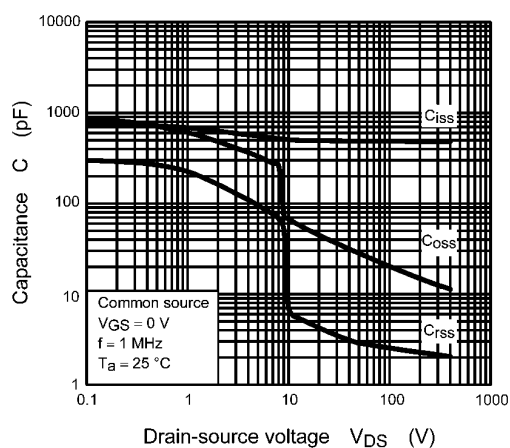
**Fig. 8.6**  $R_{DS(ON)} - I_D$



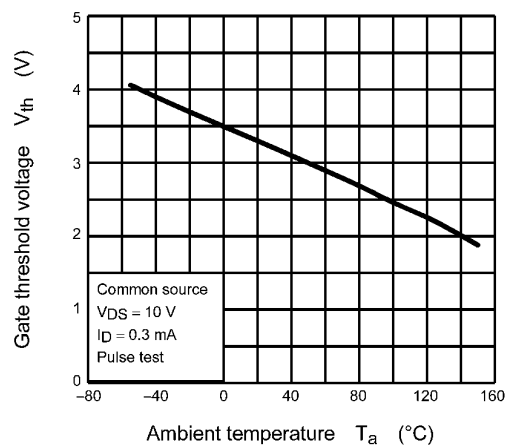
**Fig. 8.7  $R_{DS(ON)} - T_a$**



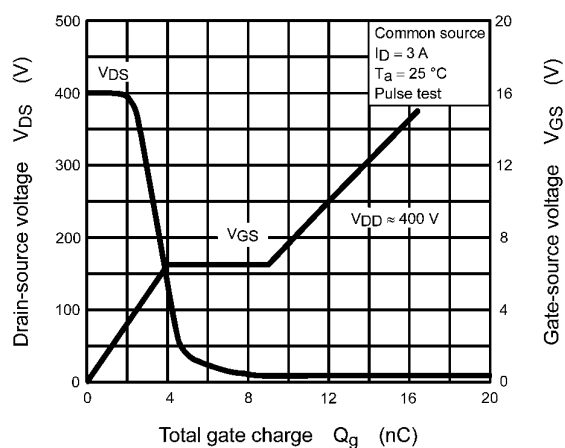
**Fig. 8.8  $I_{DR} - V_{DS}$**



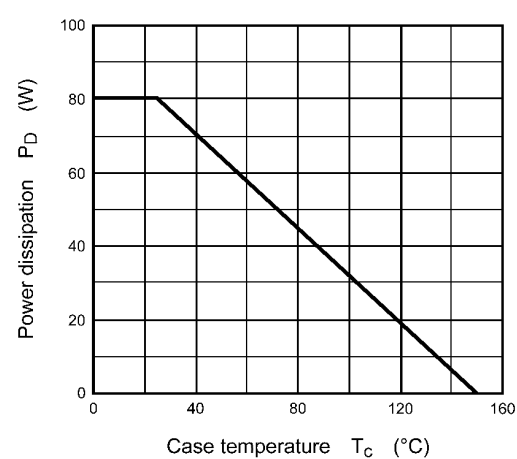
**Fig. 8.9  $C - V_{DS}$**



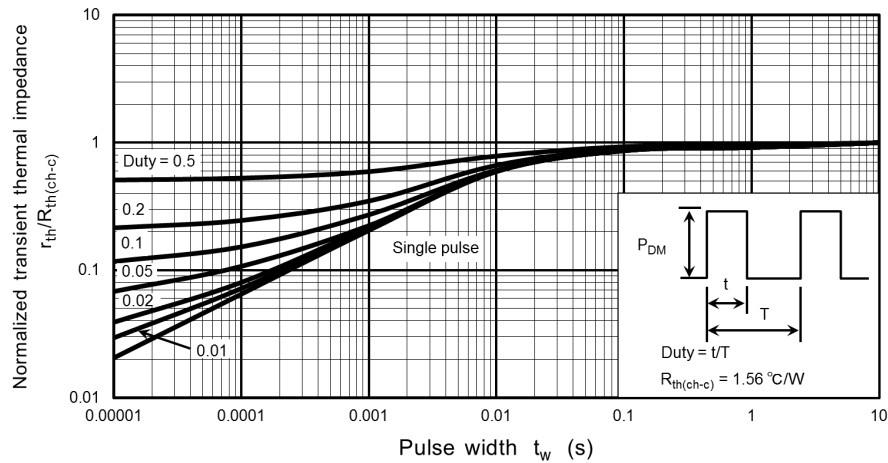
**Fig. 8.10  $V_{th} - T_a$**



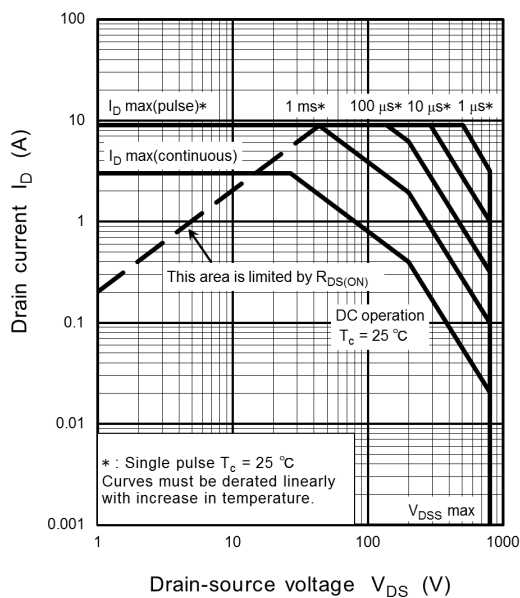
**Fig. 8.11 Dynamic Input/Output Characteristics**



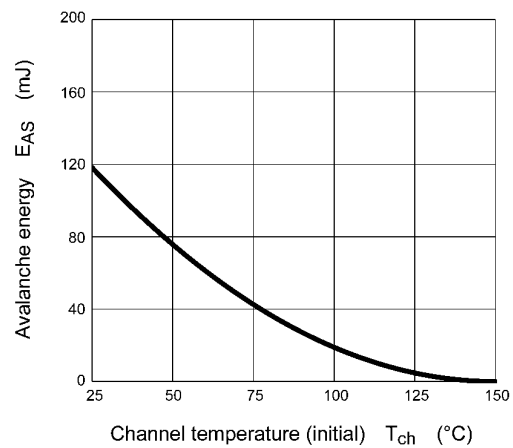
**Fig. 8.12  $P_D - T_c$   
(Guaranteed Maximum)**



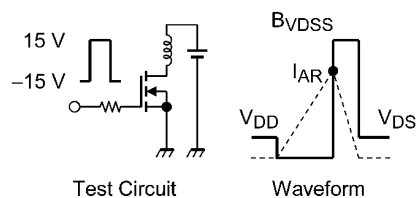
**Fig. 8.13  $r_{th} - t_w$**   
(Guaranteed Maximum)



**Fig. 8.14 Safe Operating Area**  
(Guaranteed Maximum)



**Fig. 8.15  $E_{AS} - T_{ch}$**   
(Guaranteed Maximum)



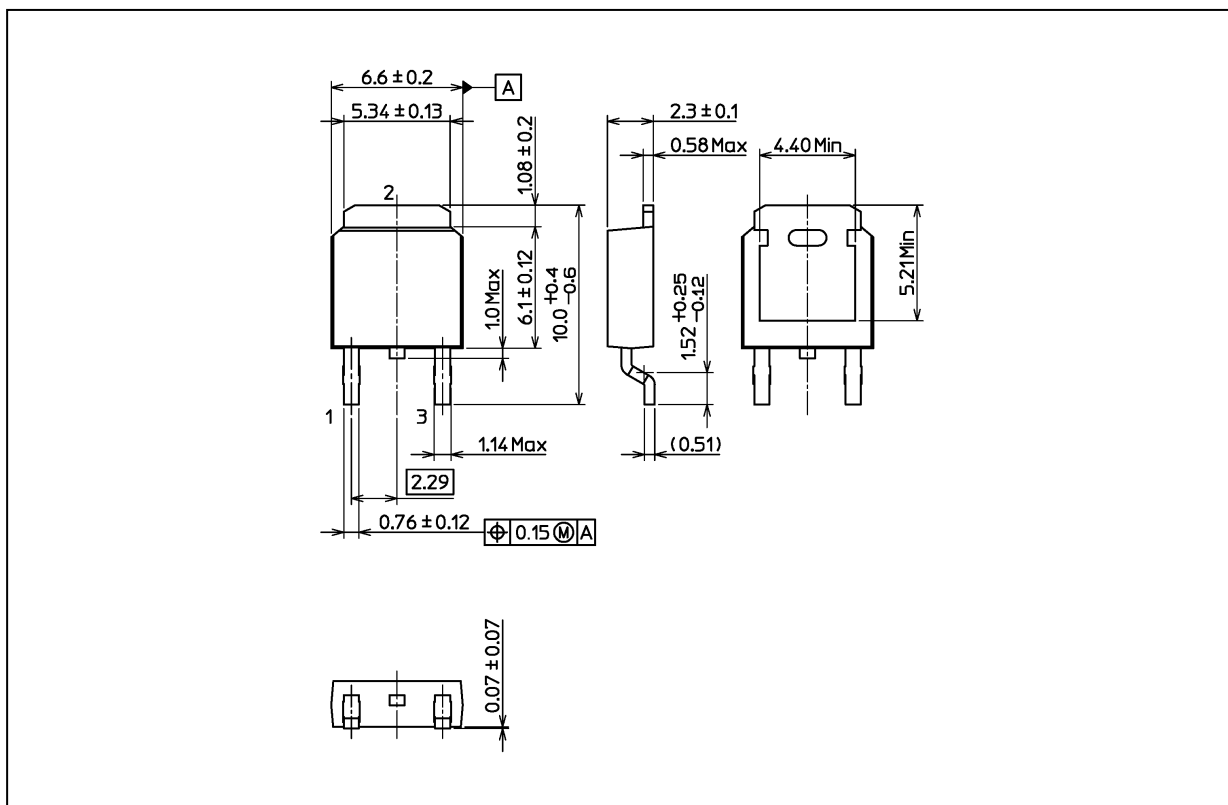
$$R_G = 25 \, \Omega, V_{DD} = 90 \, V \quad E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

**Fig. 8.16 Test Circuit/Waveform**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## Package Dimensions

Unit: mm



Weight: 0.36 g (typ.)

Package Name(s)
TOSHIBA: 2-7K1S
Nickname: DPAK



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